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The Future of Analog IC Technology

DESCRIPTION

The MP2481 is a 36V, 1.2A, white LED driver suitable for either step-down or inverting step-up/down applications. It achieves 1.2A peak output current over a wide input supply range with excellent load and line regulation. Current mode operation provides fast transient response and eases loop stabilization. Fault condition protection includes thermal shutdown, cycle-by-cycle peak current limiting, input over voltage protection, open strings protection and output short circuit protection.

The MP2481 incorporates both DC and PWM dimming onto a single control pin. The separate input reference ground pin allows for direct enable and/or dimming control for a positive to negative power conversion.

The MP2481 requires a minimum number of readily available standard external components and is available in 8-pin MSOP8E package.

EVALUATION BOARD REFERENCE

Board Number	Mode	
EV2481DH-00A	Step-down	
EV2481DH-01A	Step-up/down	

FEATURES

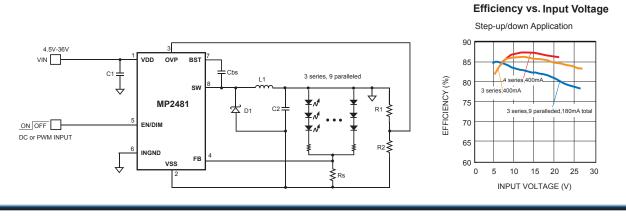
- 1.2A Maximum Output Current
- Unique Step-up/down Operation (Buck-Boost Mode)
- Wide 4.5V to 36V Operating Input Range for Step-Down Applications (Buck Mode)
- 0.30Ω Internal Power MOSFET Switch
- Fixed 1.4MHz Frequency
- Analog and PWM Dimming
- 0.2V Reference Voltage
- Up to 95% Efficiency
- 5µA Shutdown Mode
- No minimum LED required
- Stable with Low ESR Output Ceramic Capacitors
- Cycle-by-Cycle Over Current Protection
- Thermal Shutdown Protection
- Open Strings Protection
- Input Over Voltage Protection
- Output Short Circuit Protection
- Available in 8-Pin MSOP8E Package

APPLICATIONS

- General LED Illuminations
- LCD Backlight Panels
- Handheld Computers
- Automotive Internal Lighting
- Portable Multimedia Players
- Portable GPS Devices

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TYPICAL APPLICATION (STEP-UP/DOWN APPLICATION)



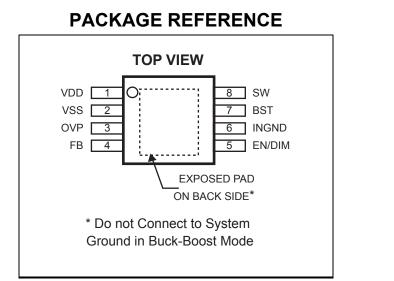
MP2481 Rev. 1.2 1/19/2010 www.MonolithicPower.com MPS Proprietary Information. Unauthorized Photocopy and Duplication Prohibited. © 2010 MPS. All Rights Reserved.



ORDERING INFORMATION

Part Number*	Package	Top Marking	Free Air Temperature (T _A)
MP2481DH	MSOP8E	2481D	–40°C to +85°C

* For Tape & Reel, add suffix –Z (e.g. MP2481DH–Z). For RoHS compliant packaging, add suffix –LF (e.g. MP2481DH–LF–Z)



ABSOLUTE MAXIMUM RATINGS (1)

	401/
Supply Voltage V _{DD} – V _{SS}	
$V_{SW} - V_{SS}$	
V _{BST}	V _{SW} + 6V
$V_{OVP} - V_{SS}$.–0.3V to +6V
$V_{EN} - V_{INGND}$.–0.3V to +6V
V _{DIM} – V _{INGND}	.–0.3V to +6V
$V_{INGND} - V_{SS}$.–0.3V to 40V
Continuous Power Dissipation (T _A	= +25°C) ⁽²⁾
	2.3W
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature	

Recommended Operating Conditions ⁽³⁾ Supply Voltage $V_{DD} - V_{SS}$4.5V to 36V Operating Junct. Temp (T_J).....-40°C to +125°C

Thermal Resistance (4) θ_{JA} θ_{JC}

MSOP8E (Exposed Pad)55 12 ... °C/W

Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-toambient thermal resistance θ_{JA} , and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J (MAX)-T_A)/ θ_{JA} . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



ELECTRICAL CHARACTERISTICS

V_{IN} = 12V, T_{A} = +25°C, all voltages with respect to $V_{\text{SS}},$ unless otherwise noted.

Symbol	Condition	Min	Тур	Max	Units
V _{FB}	$4.5V \le V_{IN} \le 36V$	0.187	0.203	0.219	V
I _{FB}	V _{FB} = 0.2V		0.2		μA
R _{DS(ON)}			0.30		Ω
	$V_{EN} = 0V, V_{SW} = 0V$			10	μA
			2.0		Α
f _{SW}	V _{FB} = 0.1V	1.0	1.4	1.8	MHz
	$V_{OVP} < 0.4V$		120		kHz
	V _{FB} = 0.1V		89		%
t _{on}			100		ns
		3.1	3.4	3.7	V
			480		mV
	V _{EN} = 2V		2.0		μA
	$V_{EN} = 0V$		0.1		
	V _{EN} Falling	0.4			V
	V _{EN} Rising			0.7	V
Ι _Q	V _{EN} = 2V, V _{FB} = 1V		0.6	0.8	mA
			150		°C
V _{OVP, th}			1.23		V
			0.1		V
	V _{FB} I _{FB} R _{DS(ON)} f _{SW} t _{ON}	$\begin{array}{c c} V_{FB} & 4.5V \leq V_{IN} \leq 36V \\ \hline I_{FB} & V_{FB} = 0.2V \\ \hline R_{DS(ON)} & & \\ & & \\ V_{EN} = 0V, V_{SW} = 0V \\ \hline & & \\ f_{SW} & V_{FB} = 0.1V \\ \hline & & \\ V_{OVP} < 0.4V \\ \hline & & \\ V_{FB} = 0.1V \\ \hline & & \\ V_{FB} = 0.1V \\ \hline & & \\ V_{EN} = 0.1V \\ \hline & & \\ V_{OVP, th} \\ \hline \end{array}$	$\begin{array}{c c c c c c c c } V_{FB} & 4.5 V \leq V_{IN} \leq 36 V & 0.187 \\ \hline I_{FB} & V_{FB} = 0.2 V & & \\ \hline R_{DS(ON)} & & & \\ & & V_{EN} = 0 V, V_{SW} = 0 V & & \\ \hline f_{SW} & V_{FB} = 0.1 V & 1.0 & \\ V_{OVP} < 0.4 V & & \\ V_{FB} = 0.1 V & & \\ V_{FB} = 0.1 V & & \\ \hline t_{ON} & & & \\ \hline & & & 3.1 & \\ \hline & & & & \\ \hline & & & & \\ V_{EN} = 0 V & & \\ \hline V_{EN} Falling & 0.4 & \\ V_{EN} Rising & \\ \hline I_Q & V_{EN} = 2 V, V_{FB} = 1 V & \\ \hline & & & \\ V_{OVP, th} & & \\ \hline \end{array}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Note:

5) Guaranteed by design.



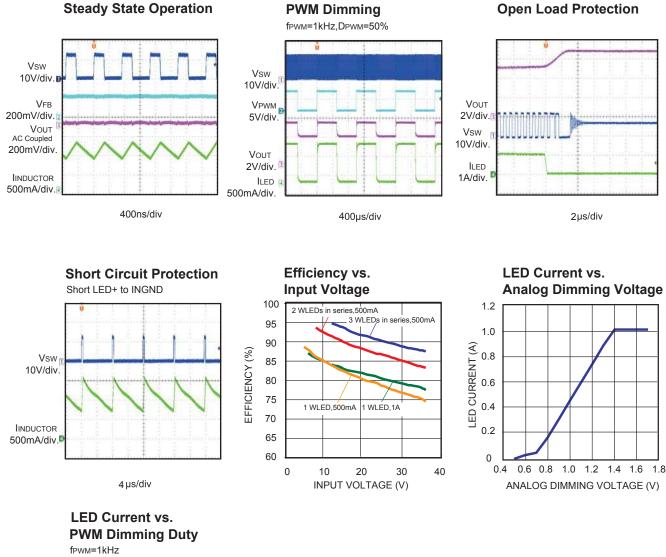
PIN FUNCTIONS

Pin #	Name	Description
1	VDD	Supply Voltage. The MP2481 operates from a +4.5V to +36V unregulated input (with respect to VSS). C1 is needed to prevent large voltage spikes from appearing at the input.
2	VSS	Power Return Pin. Connect to the lowest potential in the circuit, which is typically the anode of the Schottky rectifier. This pin is the voltage reference for the regulated output voltage. For this reason care must be taken in its layout. This node should be placed outside of the D1 to C1 ground path to prevent switching current spikes from inducing voltage noise into the part. The exposed pad is also connected to this pin.
3	OVP	Over Voltage Protection Pin. Use one external resistor voltage divider to program OVP threshold. When the OVP pin voltage (with respect to VSS) is lower than 0.4V, the chip frequency will be folded back. Program the OVP pin voltage from 0.4V to 1.23V for normal operation. When the OVP pin voltage reaches the shutdown threshold 1.23V, the switch will be turned off
4	FB	LED Current Feedback Input. MP2481 regulates the voltage across the current sensing resistor between FB and VSS. Connect the current sensing resistor from the bottom of the LED strings to VSS. The FB pin is connected to the bottom of the LED strings. The regulation voltage is 0.2V.
5	EN/DIM	On/Off Control Input and Dimming Command Input. A voltage greater than 0.7V will turn on the chip. When the EN/DIM pin voltage (with respect to INGND) rises from 0.7V to 1.4V, the LED current will change from 0% to 100% of the maximum LED current. To use PWM dimming, apply a 100Hz to 1kHz square wave signal with amplitude greater than 1.4V to this pin.
6	INGND	Input Ground Reference. This pin is the reference for the EN/DIM signal.
7	BST	Bootstrap. A capacitor is connected between SW and BST pins to form a floating supply across the power switch driver. This capacitor is needed to drive the power switch's gate above the supply voltage.
8	SW	Switch Output. SW is the source of the internal MOSFET switch. Connect to the power inductor and cathode of the Schottky rectifier.



TYPICAL PERFORMANCE CHARACTERISTICS

 V_{IN} =12V, I_{LED} =1A,one 5W WLED, Step-down application (refer to Figure 3), unless otherwise noted.



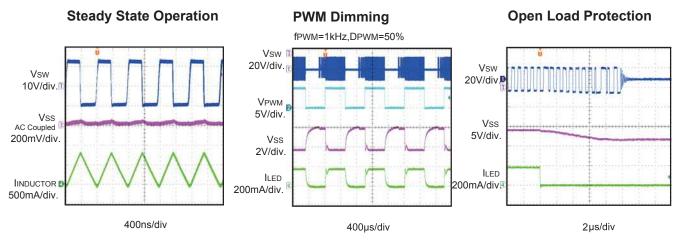
TPWM=1kHz 1.2 1.0 0.8 0.6 0.4 0.4 0.2 0 0.2 0.4 0.6 0.8 1.0 PWM Dimming Duty

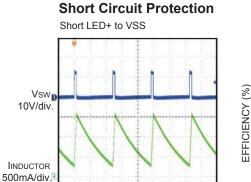
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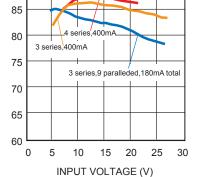
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 V_{IN} =12V, I_{LED} =180mA, 3 WLEDs in series, 9 strings, Step-up/down application (refer to Figure 4), unless otherwise noted.

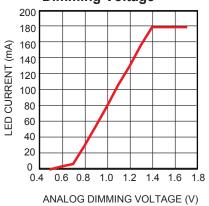




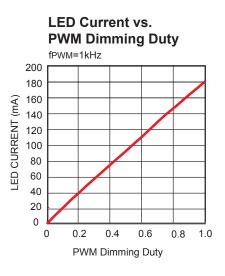
Efficiency vs. Input Voltage



LED Current vs.Analog Dimming Voltage



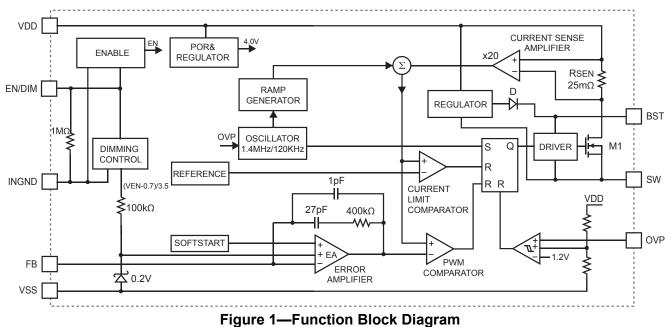
4 µs/div



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FUNCTION BLOCK DIAGRAM





OPERATION

The MP2481 is a current mode regulator. The EA output voltage is proportional to the peak inductor current.

At the beginning of a cycle, M1 is off. The EA output voltage is higher than the current sense amplifier output, and the current comparator's output is low. The rising edge of the 1.4MHz CLK signal sets the RS Flip-Flop. Its output turns on M1 thus connecting the SW pin and inductor to the input supply.

The increasing inductor current is sensed and amplified by the Current Sense Amplifier. Ramp compensation is summed to the Current Sense Amplifier output and compared to the Error Amplifier output by the PWM Comparator. When the sum of the Current Sense Amplifier output and the Slope Compensation signal exceeds the EA output voltage, the RS Flip-Flop is reset and M1 is turned off. The external Schottky rectifier diode (D1) conducts the inductor current.

If the sum of the Current Sense Amplifier output and the Slope Compensation signal does not exceed the EA output for a whole cycle, then the falling edge of the CLK resets the Flip-Flop.

The output of the Error Amplifier integrates the

voltage difference between the feedback and the 0.2V reference. The polarity is such that a FB pin voltage lower than 0.2V increases the EA output voltage. Since the EA output voltage is proportional to the peak inductor current, an increase in its voltage also increases current delivered to the output.

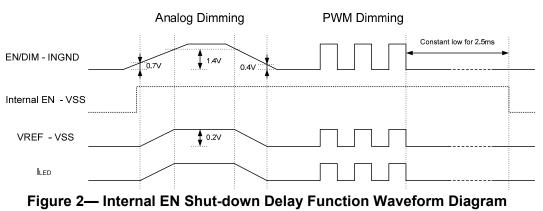
Open Strings Protection

If LED strings are open, there is no voltage on the FB pin. The duty cycle will increase until V(VDD) - V(VSS) reaches to 38V or V(OVP) -V(VSS) reaches the shutdown threshold 1.23V. The top switch will be kept off until the voltage V(VDD) - V(VSS) and V(OVP) - V(VSS)decreases sufficiently.

Dimming Control

The MP2481 allows both DC and PWM dimming. When V(EN/DIM) – V(INGND) is less than 0.4V, the chip is turned off. For analog dimming, when V(EN/DIM) – V(INGND) rises from 0.7V to 1.4V, the LED current will change from 0% to 100% of the maximum LED current. If V(EN/DIM) – V(INGND) is higher than 1.4V, maximum LED current is generated. If a PWM signal is used, its amplitude V (EN/DIM) – V (INGND) must exceed 1.4V.

The MP2481 is designed with an internal EN shut-down delay (see Figure 2). If EN is pulled down, the FB reference drops to zero immediately and the LED current decreases. But the IC keeps internal logic on for about 2.5ms. In this period, the IC may switch with very short pulses in pulse-skipping mode, while the LED current is zero since the FB reference is zero. It has benefit that the IC will start up more quickly without delay when next PWM duty comes. This function offers the possibility to extend the PWM dimming frequency and also the minimum PWM on time for further dimming depth.





APPLICATION INFORMATION

Setting the LED Current

The external resistor is used to set the maximum LED current (see the schematic on front page) through the use of the equation:

$$R_{SENSE} = \frac{0.200V}{I_{LED}}$$

Setting the OVP point

To make sure the chip functions properly, the Over Voltage Protection (OVP) resistor divider must be set with proper value, the recommended OVP point is about 1.3~1.5 times higher than the output voltage for normal operation and over voltage protection.

Selecting the Inductor

(Step-Down Applications, see Figure 3)

A 3.3μ H to 10μ H inductor with a DC current rating of at least 25% higher than the maximum load current is recommended for most applications. For highest efficiency, the inductor's DC resistance should be less than $200m\Omega$. Refer to Table 1 for suggested surface mount inductors. For most designs, the required inductance value can be derived from the following equation.

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_L \times f_{SW}}$$

Where V_{IN} is the lowest input voltage, V_{OUT} is the output voltage, ΔI_L is the inductor ripple current.

Choose the inductor ripple current to be 30% of the maximum load current. The maximum inductor peak current is calculated from:

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_{L}}{2}$$

If the calculation of above equations results in an inductance greater than 10uH, a 10uH inductor is still preferred.

Under light load conditions below 100mA, a larger inductance is recommended for improved efficiency.

Also note that the maximum recommended load current is 1A if the duty cycle exceeds 35%.

(Step up/Down Applications, see Figure 4)

Operation at step-up/down mode, the recommended inductance value can be derived from the following equation:

$$L = \frac{-V_{OUT} \times V_{IN}}{(V_{IN} - V_{OUT}) \times \Delta I_L \times f_{SW}}$$

When V_{IN} is the lowest input voltage, V_{OUT} is the output voltage (negative), ΔI_L is the inductor ripple current.

For most step-up/down applications, a 3.3uH to 22uH with suitable DC current rating is recommended. See Table 1 for suggested inductors.

Selecting the Input Capacitor

The input capacitor reduces the surge current drawn from the input supply and the switching noise from the device. The input capacitor impedance at the switching frequency should be less than the input source impedance to prevent high frequency switching current from passing through the input. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, a 4.7μ F capacitor is sufficient.

Manufacturer	Part Number	Inductance(µH)	Max DCR(Ω)	Current Rating (A)	Dimensions L x W x H (mm ³)
Toko	A921CY-4R7M	4.7	0.027	1.66	6 x 6.3 x 3
Sumida	CDRH4D28C/LD	4.7	0.036	1.5	5.1 x 5.1 x 3
Wurth Electronics	7440530047	4.7	0.038	2.0	5.8 x 5.8 x 2.8

 Table 1—Suggested Surface Mount Inductors



Selecting the Output Capacitor

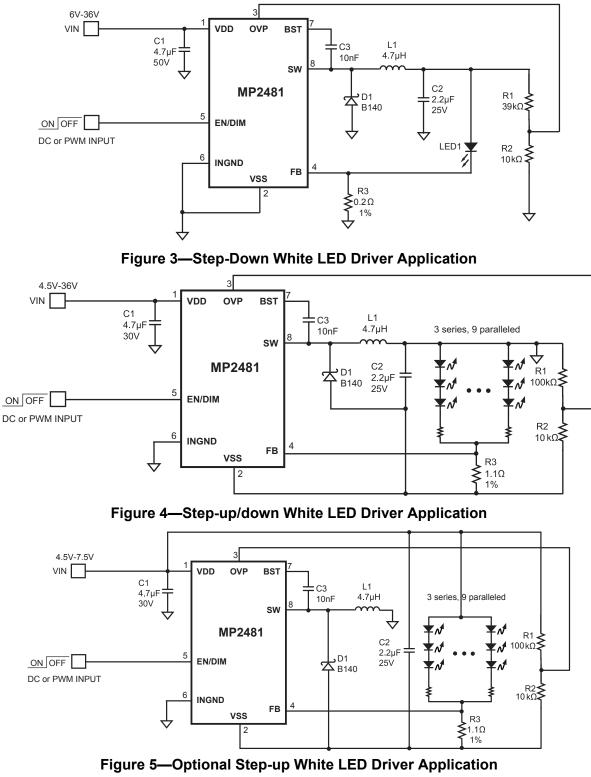
The output capacitor keeps the output voltage ripple small and ensures feedback loop stability. The output capacitor impedance should be low at the switching frequency. Ceramic capacitors with X5R or X7R dielectrics are recommended for their low ESR characteristics. For most applications, a 2.2μ F ceramic capacitor will be sufficient.

PC Board Layout Considerations

The high current paths (VSS, VDD and SW) should be placed very close to the device with short, direct and wide traces. The input capacitor needs to be as close as possible to the VDD and VSS pins. The external feedback resistors should be placed next to the FB pin. Keep the switch node traces short and away from the feedback network.

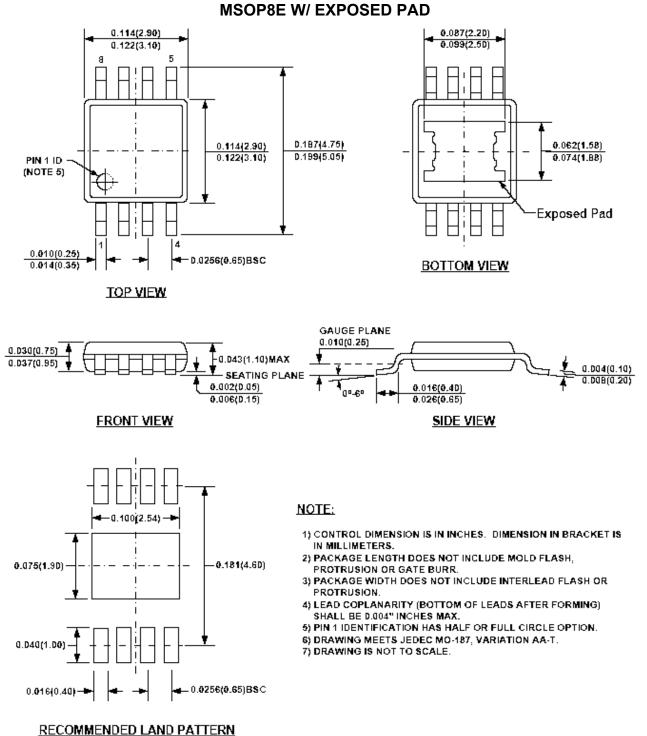


TYPICAL APPLICATION CIRCUITS





PACKAGE INFORMATION



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